

Subjects of interest Creep and stress rupture

- Objectives / Introduction
- The high temperature materials problem
- Temperature dependent mechanical behaviour
- Creep test
- Stress rupture test
- Structural change during creep
- Mechanisms of creep deformation
- Fracture at elevated temperature
- High temperature alloys

INTRODUCTION

High temperature applications



Steam Power
Plants

Subjected to
**high stress at
high
temperature**



Oil Refineries




Steam Turbine
Used in Power
Plants



High temperature materials problem

- Atoms move faster **diffusion controlled process.**

This affects mechanical properties of materials.

TEMP 

- Greater mobility of dislocations (climb).
- Increased amount of vacancies.
- Deformation at grain boundaries.
- Metallurgical changes, i.e., phase transformation, precipitation, oxidation, recrystallisation.

What is creep?

Creep occurs when a metal is subjected to a constant tensile load at an elevated temperature. In materials science, creep is the tendency of a solid material to slowly move or deform permanently under the influence of stresses.

At which temperature will material will creep?

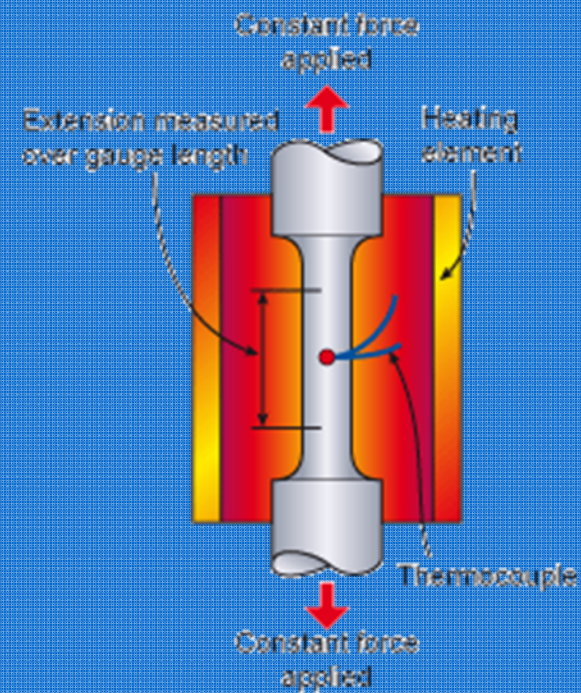
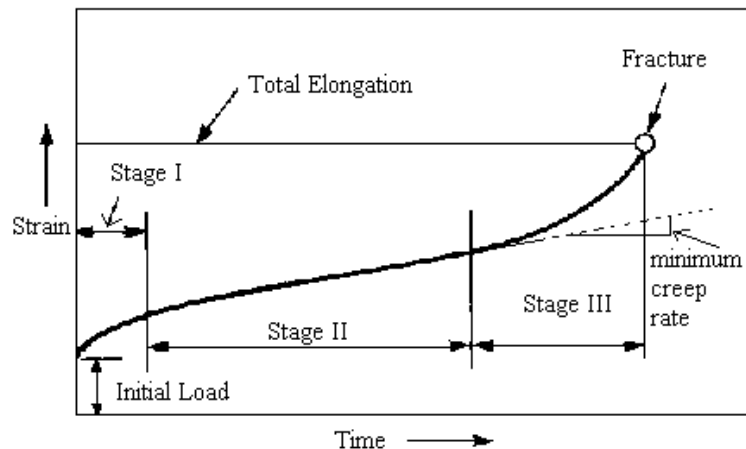
- Since materials have its own different melting point, each will creep when the homologous temperature > 0.5 .

$$\text{Homologous temp} = \frac{\text{Testing temperature}}{\text{Melting temperature}} > 0.5$$

- The **creep test** measure *the dimensional changes* which occur when subjected to high temperature.
- The **rupture test** measures the effect of temperature on the long-time load bearing characteristics.

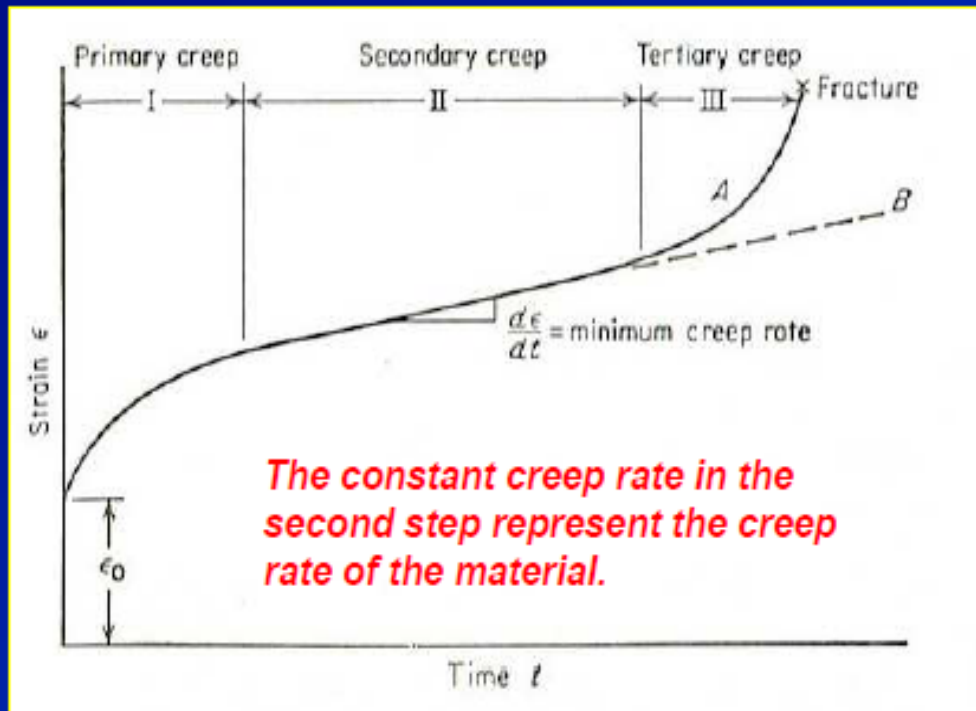
Creep Test

The creep test is carried out by applying a constant load to a tensile specimen maintained at a constant temperature



Schematic creep testing machine

The creep curve



Typical creep curve showing three stages of creep

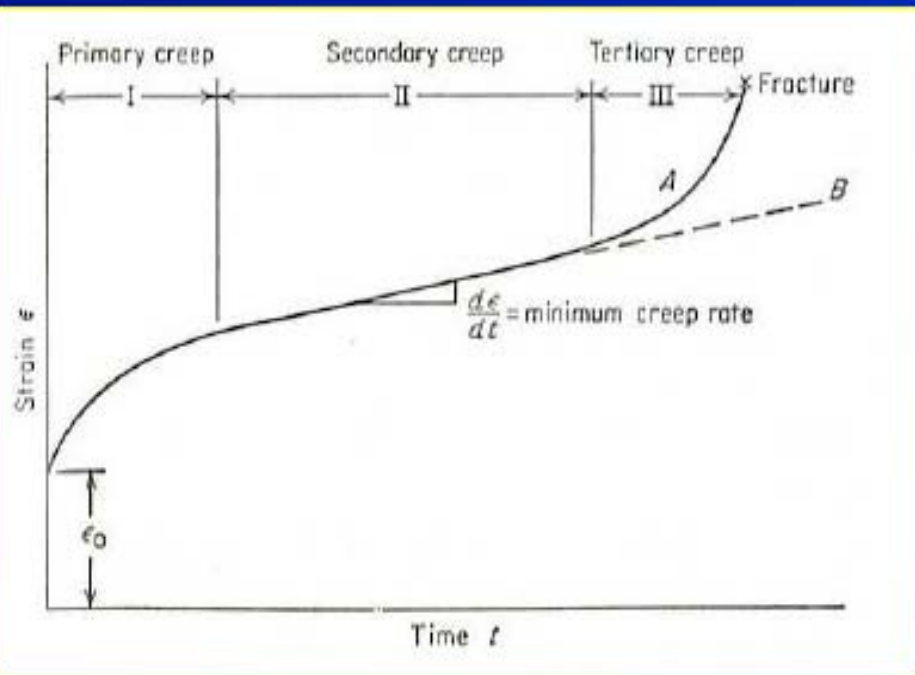
Notes: B curve is obtained when the stress rather than the load is maintained.

ϵ_0 is instantaneous strain on loading which is partly **recoverable** with time (anelastic) and partly **nonrecoverable** with time (plastic).

A **typical creep curve** shows three distinct stages with different creep rates. After an initial rapid elongation ϵ_0 , the creep rate decrease with time until reaching the steady state.

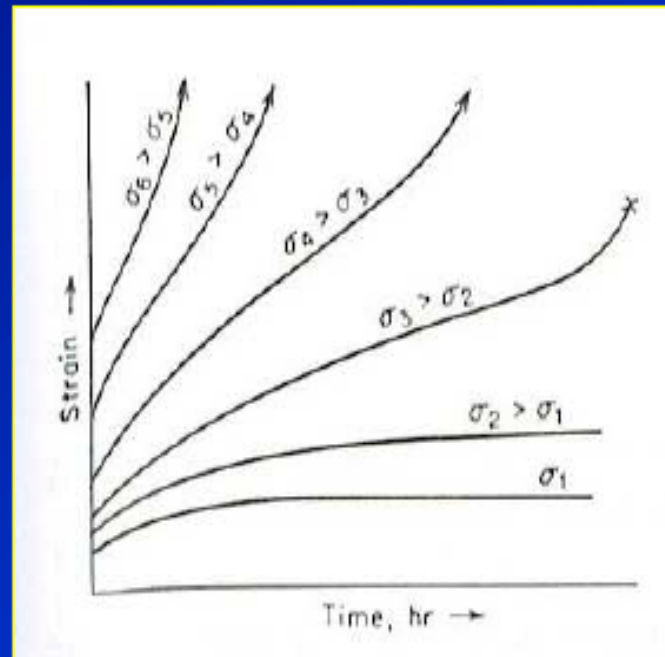
- 1) **Primary creep** provides decreasing creep rate.
- 2) **Secondary creep** gives the representing constant creep rate.
- 3) **Tertiary creep** yields a rapid creep rate till failure.

Three stages of creep



- 1) **Primary creep** is a period of transient creep. The creep resistance of the material increases due to material deformation. Predominate at low temperature test such as in the creep of lead at RT.
- 2) **Secondary creep** provides a nearly constant creep rate. The average value of the creep rate during this period is called the **minimum creep rate**.
- 3) **Tertiary creep** shows a rapid increase in the creep rate due to effectively reduced cross-sectional area of the specimen.

Effect of stress on creep curves at constant temperature



The shape of creep curve will slightly change according to the *applied stress* at a constant temperature.

Applied stress



Strain



Temp



Creep rate



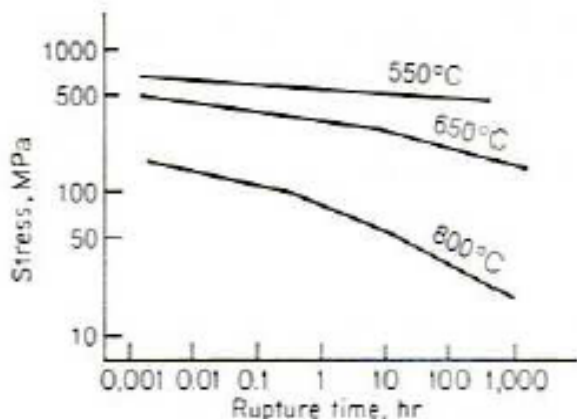
The stress rupture test

Creep test

Stress rupture test

<u>Load</u>	Low load	high load
<u>Creep rate</u>	minimum creep rate	high creep rate
<u>Test period</u>	2000-10000 h	1000 h
<u>Total strain</u>	0.5%	50%
<u>Strain gauge</u>	Good strain measuring devices	Simpler strain measuring devices

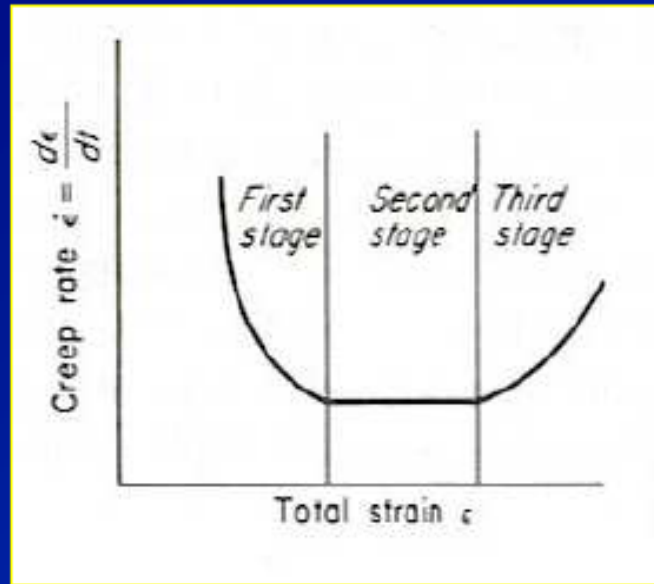
The **rupture test** is carried out in a similar manner to the **creep test** but at a **higher stress level** until the specimen fails and the **time at failure** is measured.



Stress rupture- time data on log-log scale

- **Rupture strength** and **failure time** are plotted, normally showing a **straight line**.
- **Changing of the slope** indicates **structural changes in the material**, i.e., transgranular → intergranular fracture, oxidation, recrystallisation, grain growth, spheroidization, precipitation.
- Direct application in **design**.

Structural changes during creep



Creep rate and total strain relationship

Different creep rates result from **changes in internal structure** of the materials with creep rate and time.

There are **three principal deformation processes** at elevated temperature.

1) Deformation by slip

- More slip systems operate at high temperature
- Slip bands are coarser and widely spaced.

2) Subgrain formation

- Creep deformation produces inhomogeneity especially around grain boundaries, allowing dislocations to arrange themselves into a low-angle grain boundary. Easy for metals with high stacking fault energy.

3) Grain boundary sliding

- Produced by shear process and promoted by increasing temperature/or decreasing strain rate.
- Results in grain boundary folding or grain boundary migration

Mechanisms of creep deformation

The chief creep deformation mechanisms can be grouped into;

1) Dislocation glide

*Involves dislocation moving along slip planes and overcoming barriers by thermal activation.
Occurs at high stress.*

2) Dislocation creep

Involves dislocation movement to overcome barriers by diffusion of vacancies or interstitials.

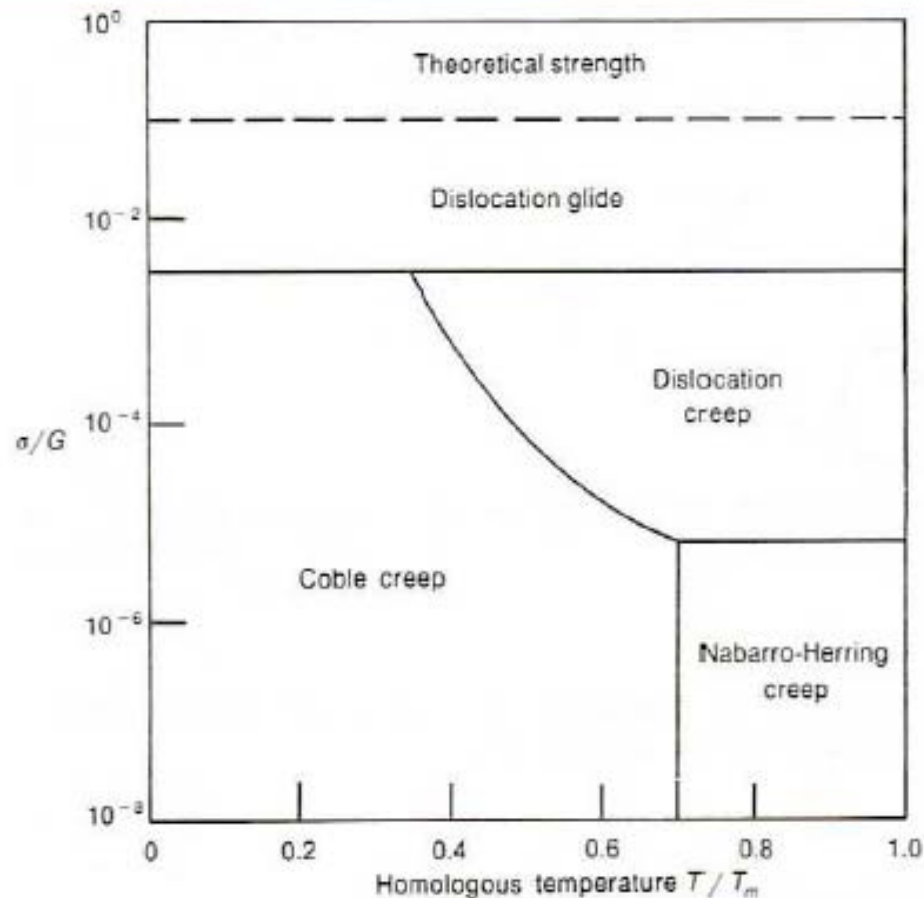
3) Diffusion creep

Involves the flow of vacancies and interstitials through a crystal under the influence of applied stress.

4) Grain boundary sliding

Involves the sliding of grains past each other.

Deformation mechanism maps



Simplified deformation mechanism map.

- The various regions of the map indicate the **dominant deformation mechanism** for the combination of stress and temperature.
- At the **boundary**, two mechanisms occur.

Note: G is the shear modulus

Activated energy for steady-state creep

- **Steady-state creep deformation** predominates at temperatures above $0.5T_m$.
- Steady state creep can be expressed by

$$\dot{\epsilon}_s = Ae^{-Q/RT}$$

Eq.1

Where **Q** = the activated energy for the rate-controlling process
A = the material structural constant
T = the absolute temperature
R = the universal gas constant

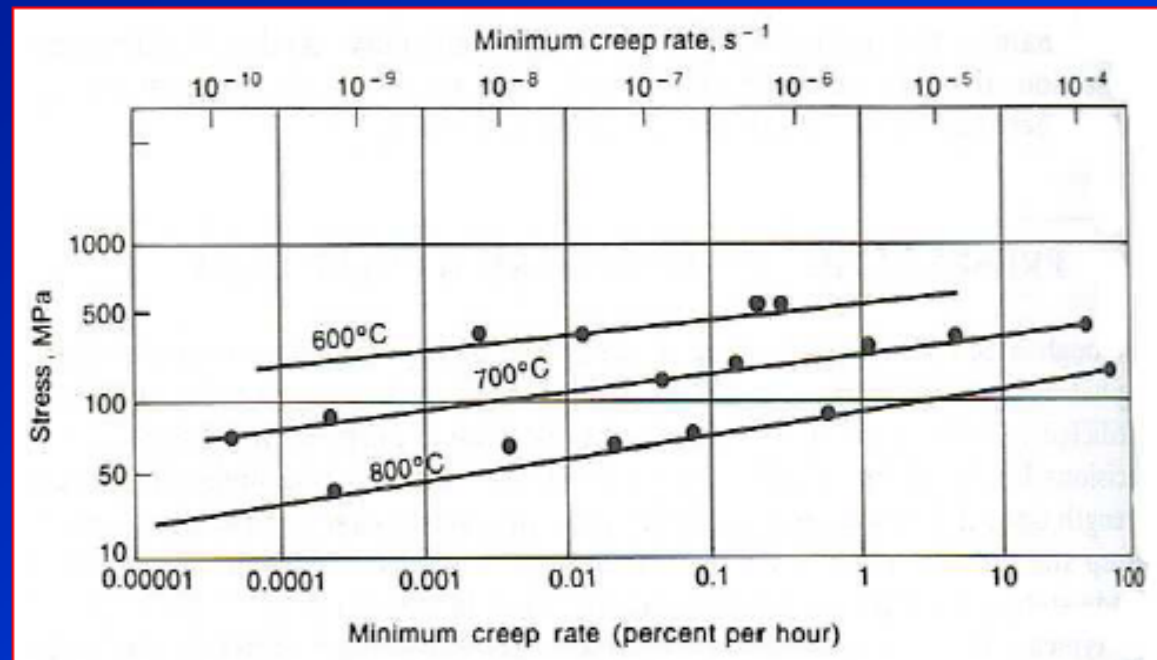
- The **activated energy Q** can be calculated by assuming the temperature interval is small so that the creep mechanisms is not expected to change.

$$A = \dot{\epsilon}_1 e^{Q/RT_1} = \dot{\epsilon}_2 e^{Q/RT_2}$$
$$Q = \frac{R \ln(\dot{\epsilon}_1 / \dot{\epsilon}_2)}{(1/T_2 - 1/T_1)}$$

Eq.2

Presentation of engineering creep data

Creep strength is defined as the stress at a given temperature, which produces a **steady-state creep rate** (10^{-11} to 10^{-8} s $^{-1}$.)



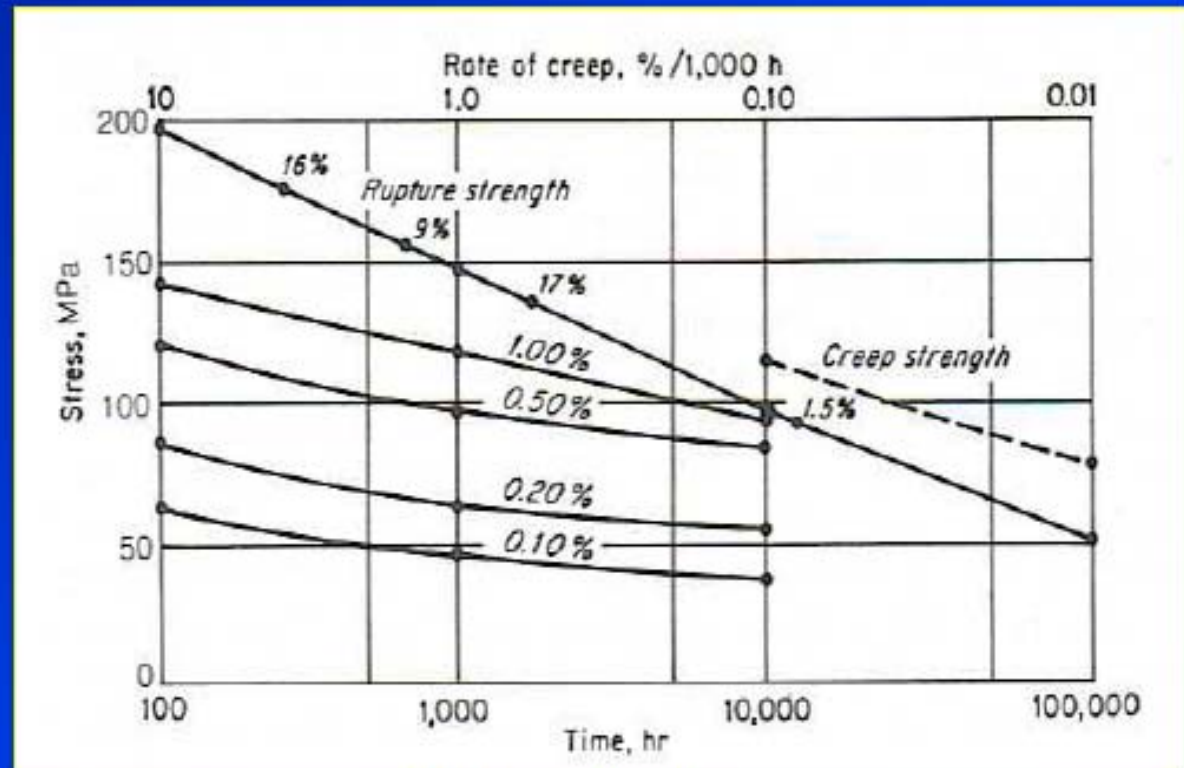
Stress vs minimum creep rate

- **Log-log plot** is used so that the extrapolation of one log-cycle represents a **tenfold change**.

Creep data

Creep data can also be presented as a **plot of stress and time** to produce different amounts of total strain.

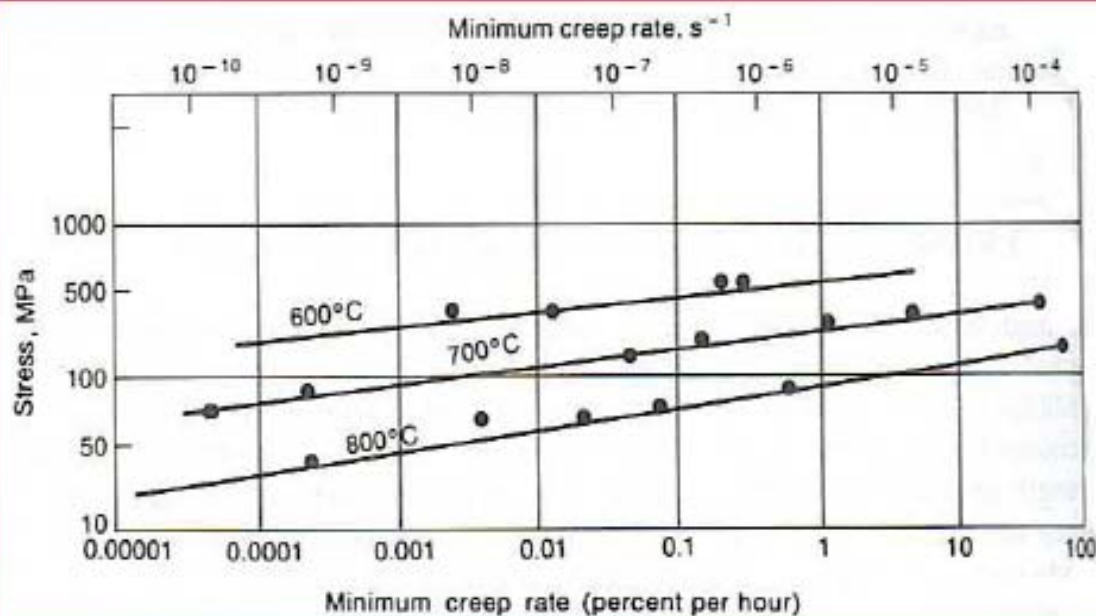
- The upper most curve is the **stress rupture curve**.
- The percentage beside each data point is the **percentage reduction at failure**.



Deformation time curve

Example: Determine the working stress at 600°C and 800°C for type 316 stainless steel if the design criterion is a creep strength based on 1 percent extension in 1000 hr. Use a factor of safety of 3.

$$1\% \text{ creep in } 1000h = 10^{-5} h^{-1} = \frac{10^{-5}}{3600} s^{-1} = 2.8 \times 10^{-9} s^{-1}$$



From stress and minimum creep rate curve, the **working stress** using the safety factor of 3 can be obtained in the table below.

Temperature	Creep strength, MPa	Working stress, MPa
600°C	210	70
800°C	30	10